

NEXT GENERATION
TRANSPORT AIRCRAFT

Web Seminar

University of Washington, Tohoku University and Toray Composites (America), Inc.

Please join us on Tuesday, November 17th at 16:00 PST for a joint seminar between University of Washington, Tohoku University, and Toray Composites (America)

PROGRAM

17:00-17:15 “Molecular dynamics simulation of adhesion between metal and epoxy resin”

Kyosuke Inuyama

Department of Aerospace Engineering, Tohoku University



17:15-17:30 “Multidisciplinary optimization of epoxy resin based on molecular dynamics simulation”

Yutaka Oya

Department of Aerospace Engineering, Tohoku University

